

Microsemi Corporation

August 17, 2016

Product/Process Change Notification No: 1613K

Change Classification: Major; Material; Transition

Subject: VSC3340XJJ-01 and VSC3340XJJ-31 Pb-free Bump Conversion Amendment

Description of Change: This notification is an amendment to the previously issued PCN1613. This amendment extends the last time buy for the Pb-bumped VSC3340XJJ-01 and VSC3340XJJ-31 devices. The last order date is extended to August 7, 2018 with a last shipment date of August 7, 2019.

All last-time-buy orders must be booked as non-cancelable non-returnable (NCNR) by the last order date specified. Acceptance of last-time-buy orders is subject to product availability and done at the discretion of Microsemi Corporation. Every effort will be made to fulfill these orders. Microsemi may extend or shorten the last order date depending on the inventory depletion rate.

Reason for Change: Microsemi is extending the last order date to accommodate the extension of RoHS exemption 15 to the year 2021.

Application Impact: There is no anticipated impact to applications.

Method of Identifying Changed Product: Pb-free bump devices will be identified by the device markings and ordering part numbers VSC3340YJJ-01 and VSC340YJJ-31.

Products Affected by this Change:

VSC3340XJJ-01, VSC3340XJJ-31

Production Shipment Schedule: Pb-free bump devices will begin shipping once the Pb-bumped device inventory is depleted.

Qualification Data: The VSC3340YJJ-01 and VSC3340YJJ-31 datasheets, qualification reports, and material composition declarations are available on the Microsemi web site at www.microsemi.com.

Sample Availability:

Please contact your local Microsemi representative to place sample orders.

Contact Information:

If you have further questions related to this topic, contact Microsemi's Technical Support at: ENT.quality@microsemi.com

Regards,

Microsemi Corporation

Microsemi Corporation

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MSC-F-0003 Rev 4

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Any projected dates in this PCN are based on the most current product information at the time this PCN is being issued, but they may change due to unforeseen circumstances. For the latest schedule and any other information, please contact your local Microsemi Sales Office, the factory contact shown above, or your local distributor.

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Microsemi Corporation (Nasdaq: MSCC) offers a comprehensive portfolio of semiconductor and system solutions for aerospace & defense, communications, data center and industrial markets. Products include high-performance and radiation-hardened analog mixed-signal integrated circuits, FPGAs, SoCs and ASICs; power management products; timing and synchronization devices and precise time solutions, setting the world's standard for time; voice processing devices; RF solutions; discrete components; enterprise storage and communication solutions; security technologies and scalable anti-tamper products; Ethernet solutions; Power-over-Ethernet ICs and midspans; as well as custom design capabilities and services. Microsemi is headquartered in Aliso Viejo, California, and has approximately 4,800 employees globally. Learn more at www.microsemi.com.